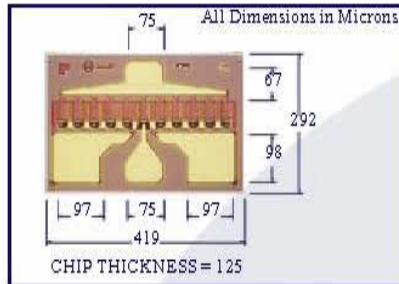


# MwT-A9

## 18 GHz High Gain, Low Noise GaAs FET



DOWNLOAD ADDITIONAL DATA [WWW.MWTINC.COM](http://WWW.MWTINC.COM)



### FEATURES

- IDEAL FOR HIGH DYNAMIC RANGE RECEIVER APPLICATIONS
- 1.6 dB NOISE FIGURE AT 12 GHz
- +24.5 dBm OUTPUT POWER AT 12 GHz
- 9 dB SMALL SIGNAL GAIN AT 12 GHz
- 0.3 MICRON REFRACTORY METAL/GOLD GATE
- 750 MICRON GATE WIDTH
- AVAILABLE IN CHIP AND PACKAGES

### DESCRIPTION

The MwT-A9 is a GaAs MESFET device whose nominal quarter-micron gate length and 750 micron gate width make it ideally suited to applications requiring high-gain in the 500 MHz to 18 GHz frequency range with moderate power output while exhibiting low noise figure. The chip is produced using MwT's reliable metal system and devices from each wafer are screened to insure reliability. All chips are passivated using MwT's patented "Diamond-Like Carbon" process for increased durability. Designers can use MwT's unique BIN selection feature to choose devices from narrow Idss ranges, insuring consistent circuit operation.

### DC SPECIFICATIONS AT Ta = 25°C

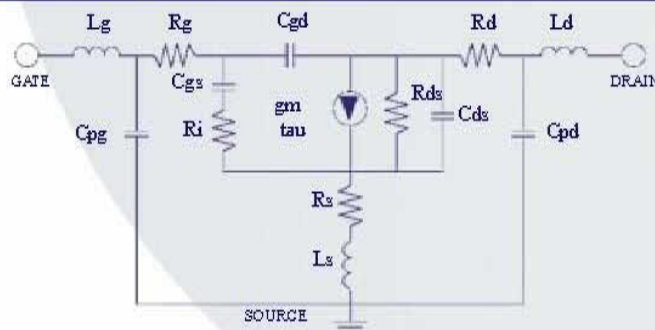
SYMBOL	PARAM. & CONDITIONS	UNITS	MIN	TYP	MAX
IDSS	Saturated Drain Current Vds= 4.0 V VGS= 0.0 V	mA	78		282
Gm	Transconductance Vds= 2.0 V VGS= 0.0 V	mS	95	120	
Vp	Pinch-off Voltage Vds= 3.0 V IDS= 5.0 mA	V		-2.0	-5.0
BVGSO	Gate-to-Source Breakdown Volt. Igs= -1.0 mA	V	-5.0	-10.0	
BVGDO	Gate-to-Drain Breakdown Volt. Igd= -1.0 mA	V	-6.0	-10.0	
Rth	Thermal Resistance MwT-A9 Chip, A971 Resistance MwT-A970, A973	°C/W		70	175*

\*Overall Rth depends on case mounting.

### RF SPECIFICATIONS AT Ta = 25°C

SYMBOL	PARAMETERS AND CONDITIONS	FREQ	UNITS	MIN	TYP
P1dB	Output Power at 1 dB Compression VDS= 5.0 V Idss= 0.6 IDS= 120mA	12 GHz	dBm	23.0	24.5
SSG	Small Signal Gain VDS= 5.0 V Idss= 0.6 IDS= 120mA	12 GHz	dB	8.5	9.0
NFopt	Optimum Noise Figure VDS= 3.0 V IDS= 30mA	12 GHz	dB		1.8
GA	Gain at Optimum Noise Figure VDS= 3.0 V IDS= 30mA	12 GHz	dB	6.0	6.5

### DEVICE EQUIVALENT CIRCUIT MODEL



### PARAMETER

### VALUE

Source Resistance	Rs	0.80	Ω
Source Inductance	Ls	0.04	nH
Drain-Source Resistance	Rds	100.0	Ω
Drain-Source Capacitance	Cds	0.08	pF
Drain Resistance	Rd	1.0	Ω
Drain Pad Capacitance	Cpd	0.10	pF
Drain Inductance	Ld	0.28	nH
Gate Bond Wire Inductance	Lg	0.10	nH
Gate Pad Capacitance	Cpg	0.03	pF
Gate Resistance	Rg	0.50	Ω
Gate-Source Capacitance	Cgs	0.78	pF
Channel Resistance	Ri	0.8	Ω
Gate-Drain Capacitance	Cgd	0.10	pF
Transconductance	gm	120.0	mS
Transit Time	tau	1.0	psec

### ORDERING INFORMATION

Chip	MwT-A9
Package 70	MwT-A970
Package 71	MwT-A971
Package 73	MwT-A973

#### NOTE:

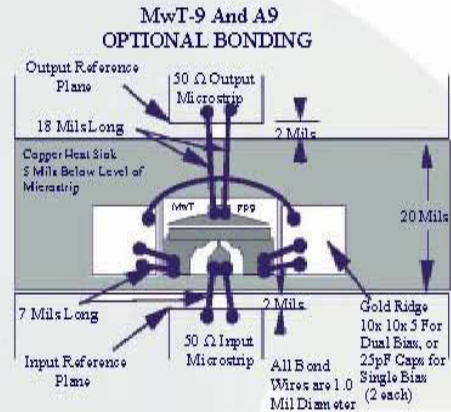
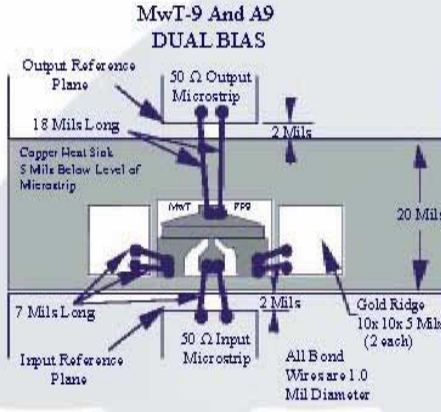
For Package information, please see supplementary application note from our website at [www.mwtinc.com](http://www.mwtinc.com). When placing an order or inquiry, please specify BIN range, wafer no. if known, and screening level required.

4268 Solar Way, Fremont, CA 94538 | Email [sales@mwtinc.com](mailto:sales@mwtinc.com) | Phone (510) 651-6700 | Fax (510) 952-4000

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# MwT-A9

18 GHz High Gain, Low Noise  
GaAs FET



■ Absolute Maximum    ■ Continuous Maximum

### MAXIMUM RATINGS AT Ta = 25°C

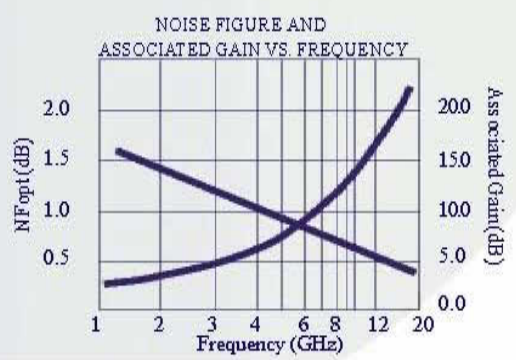
SYMBOL	PARAMETER	UNITS	CONT MAX <sup>1</sup>	ABSOLUTE MAX <sup>2</sup>
VDS	Drain to Source Voltage	V	See Safe Operating Limits	
Tch	Channel Temperature	°C	+150	<b>+175</b>
Tst	Storage Temperature	°C	-65 to +150	<b>+175</b>
Pin	RF Input Power	mW	<b>240</b>	<b>360</b>

NOTES: 1. Exceeding any one of these limits in continuous operation may reduce the mean-time-to-failure below the design goals.  
2. Exceeding any one of these limits may cause permanent damage.

### TYPICAL NOISE PARAMETERS

MwT-A9LN Chip: VDS= 3.0V IDS= 35mA

FREQUENCY GHz	NF MIN dB	GAMMA OPT		Rn/50
		MAG	ANGLE	
1.00	0.30	0.85	4.5	0.19
2.00	0.33	0.69	36.8	0.18
4.00	0.62	0.56	73.4	0.19
6.00	0.93	0.52	106.3	0.19
10.00	1.48	0.57	152.0	0.17
12.00	1.73	0.61	167.3	0.17
16.00	2.19	0.68	-169.8	0.16
18.00	2.40	0.71	-160.8	0.15



### Bin Selection Guide

Bin	A	B	C	D
Idss	78-	114-	150-	222-
Range	114	150	222	258

### BIN ACCURACY STATEMENT

When placing order or inquiring, please specify BIN range, wafer no., if known, and screening level required.

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